

NOTES:  
 ELECTRICAL CHARACTERISTICS  
 CONTACT CURRENT RATING: 0.5 Amps Max.  
 VOLTAGE RATING: 30 Volts AC (RMS)/DC Max.  
 CONTACT RESISTANCE: 80 MILLOHMS MAX.  
 DIELECTRIC WITHSTANDING VOLTAGE: 300V DC

MATERIALS  
 CONTACTS: COPPER ALLOY  
 HOUSING: HIGH TEMPERATURE THERMOPLASTIC 94V-0, BLACK

FINISH:  
 OPTION 1:  
 CONTACT ARER: 15u" MIN GOLD OVER 50u" MIN NICKEL  
 SOLDER ARER: 100u" MIN TIN OVER 50u" MIN NICKEL

OPTION 2:  
 CONTACT ARER: 30u" MIN GOLD OVER 50u" MIN NICKEL  
 SOLDER ARER: 100u" MIN TIN OVER 50u" MIN NICKEL

ENVIRONMENT  
 OPERATION TEMPERATURE: -20°C TO +85°C

THIS PRODUCT COMPLY TO ROHS DIRECTIVE 2002/95/EC

PCIE-SWP-038-LF  
 LEADFREE

RoHS Compliant

**MORETHANALL**  
 CONNECTORS  
 ASSEMBLIES

PART NO. PCIE-SWP-038

DWG NO. PCIE-SWP-038

FILE NO.

CHECKED BY CY

DRAWING BY

PROJECTION

TOLERANCES ARE  
 X ± 0.25  
 .X ± 0.15  
 .XX ± 0.15  
 .XXX ± 0.05  
 ANG

DESCRIPTION: QSFP CONNECTOR

AREA

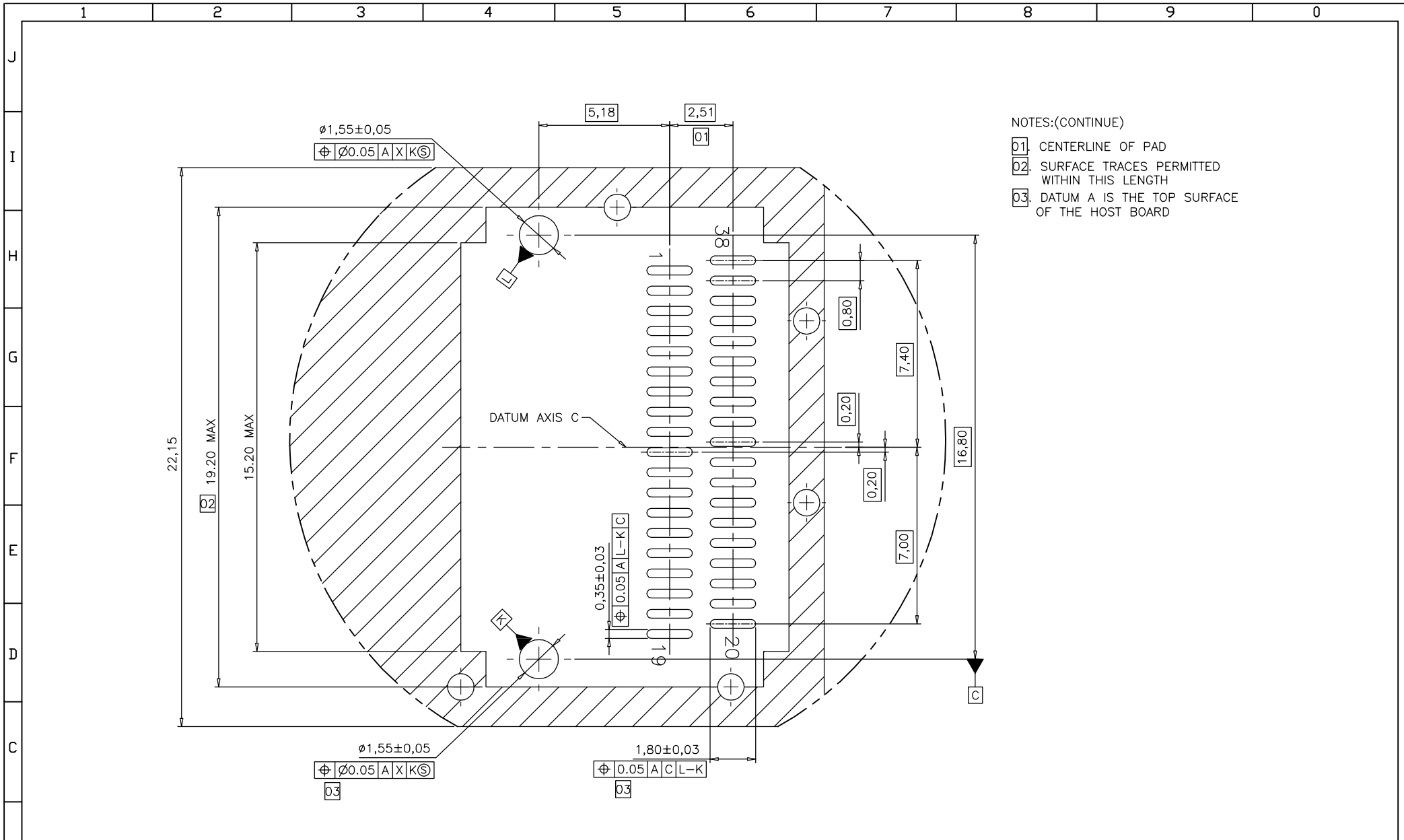
REVISIONS

DATE

焜倫股份有限公司

UNIT / mm

SCALE 1:1



- NOTES:(CONTINUE)
- 01. CENTERLINE OF PAD
  - 02. SURFACE TRACES PERMITTED WITHIN THIS LENGTH
  - 03. DATUM A IS THE TOP SURFACE OF THE HOST BOARD



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TOLERANCES ARE  
 X. ± 0.25  
 .X ± 0.15  
 .XX ± 0.15  
 .XXX ± 0.05  
 ANG

DESCRIPTION:

焯倫股份有限公司

UNIT / mm

SCALE 1:1

PROJECTION

AREA

REVISIONS

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